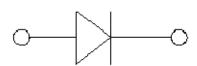




# **Small Signal Schottky Diode**





#### **Features**

V<sub>R</sub> 100VI<sub>FAV</sub> 200mA

#### **Mechanical Data**

• Package: SOD-123

• **Terminals**: Tin plated leads, solderable per J-STD-002 and JESD22-B102

• Polarity: Cathode line denotes the cathode end

• Marking: Z41

### ■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Conditions	VALUE
Repetitive peak reverse voltage	$V_{RRM}$	V		100
Continuous forward current	I <sub>F</sub>	mA		200
Non-Repetitive Peak Forward Surge Current	I <sub>FSM</sub>	А	t <sub>p</sub> =10ms	1
Junction temperature	T <sub>j</sub>	°C		125
Storage temperature range	$T_{stg}$	°C		-55 to +125
Thermal Resistance Junction to Ambient Air	$R_{ heta JA}$	°C /W		500

### **■Electrical Characteristics** (T<sub>a</sub>=25°C Unless otherwise specified)

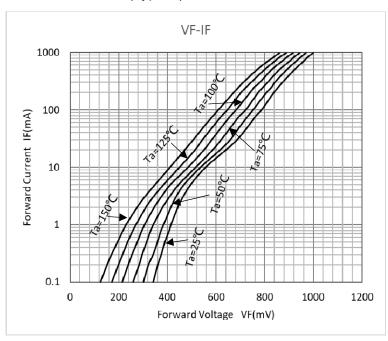
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PARAMETER	SYMBOL	UNIT	Conditions	VALUE		
Maximum Forward voltage	V <sub>F</sub>	mV	I <sub>F</sub> =1mA	450		
		mV	I <sub>F</sub> =200mA	1000		
Maximum Reverse current	I <sub>R</sub>	uA	V <sub>R</sub> =50V,T <sub>A</sub> =25°C	0.1		
		uA	V <sub>R</sub> =50V,T <sub>A</sub> =100°C	20		
Minimum Breakdown voltage	V <sub>R</sub>	V	I <sub>R</sub> =10μA	100		
Diode capacitance	C <sub>D</sub>	pF	V <sub>R</sub> =1V, f=1MH <sub>Z</sub>	10		

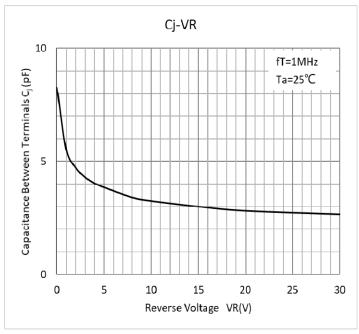


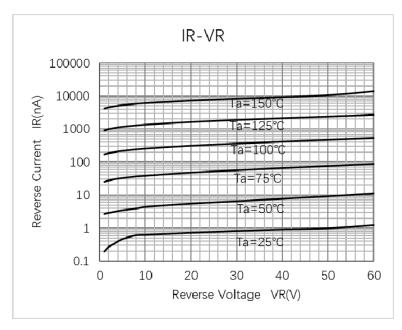
**■Ordering Information** (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
BAT41ZFILM	F2	Approximate 0.011	3000	30000	120000	7" reel

## **■ Characteristics** (Typical)

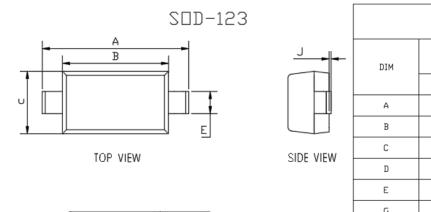








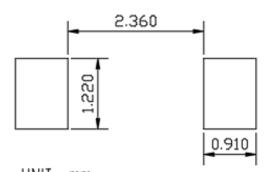
#### **■ Outline Dimensions**



DIM	INC	HES	ММ		
	MIN	MAX	MN	MAX	
А		0.140	0.152	3.550	3.850
В		0.100	0.112	2.550	2.850
С		0.055	0.071	1.400	1.800
D		0.037	0.053	0.950	1.350
Ε		0.020	0.028	0.510	0.710
G		0.006	0.018	0.150	0.450
Н		0.003	0.010	0.080	0.250
J		0.000	0.006	0.000	0.150
9		0	8*	0	8°

DIMENSIONS

### ■ Soldering Footprint



G

SIDE VIEW

UNIT: mm

SUGGESTED SOLDER PAD LAYOUT



#### **Disclaimer**

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